

Single Phase Rectifier Bridge

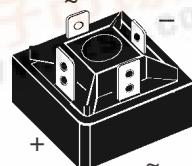
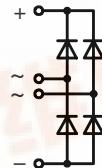
Standard and Avalanche Types

V_{RSM} V	V_{BRmin} ① V	V_{RRM} V	Standard Types	Avalanche Types
900		800	VBO 25-08NO2	
1300	1230	1200	VBO 25-12NO2	VBO 25-12AO2
1500	1430	1400	VBO 25-14NO2	VBO 25-14AO2
1700	1630	1600	VBO 25-16NO2	VBO 25-16AO2

① For Avalanche Types only

$$I_{dAV} = 38 \text{ A}$$

$$V_{RRM} = 800-1600 \text{ V}$$

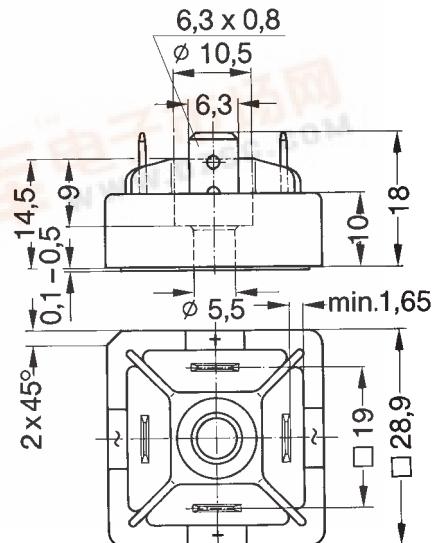


Symbol	Test Conditions	Maximum Ratings			Features
I_{dAV} ②	$T_c = 85^\circ\text{C}$, module	38	A		Avalanche rated parts available
I_{dAVM}	module	40	A		Package with DCB ceramic base plate
P_{RSM}	$T_{VJ} = T_{VJM}$ $t = 10 \mu\text{s}$	3.4	kW		Isolation voltage 3600 V~
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $V_R = 0$	370	A		Planar passivated chips
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	390	A		Low forward voltage drop
I^2t	$T_{VJ} = T_{VJM}$ $V_R = 0$	320	A		1/4" fast-on terminals
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	340	A		UL registered E 72873
T_{VJ}	$T_{VJ} = 45^\circ\text{C}$	680	A^2s		
	$V_R = 0$	640	A^2s		
T_{VJM}	$T_{VJ} = T_{VJM}$ $V_R = 0$	510	A^2s		
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	470	A^2s		
T_{stg}		-40...+150	$^\circ\text{C}$		
		150	$^\circ\text{C}$		
		-40...+125	$^\circ\text{C}$		
V_{ISOL}	50/60 Hz, RMS	3000	V~		
	$I_{ISOL} \leq 1 \text{ mA}$	3600	V~		
M_d	Mounting torque (M5)	1.5-2	Nm		
	(10-32 UNF)	13-18	lb.in.		
Weight	typ.	15	g		

Symbol	Test Conditions	Characteristic Values		
I_R	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$	\leq	0.3	mA
	$V_R = V_{RRM}$; $T_{VJ} = T_{VJM}$	\leq	5	mA
V_F	$I_F = 55 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$	\leq	1.36	V
V_{TO}	For power-loss calculations only		0.85	V
	$T_{VJ} = T_{VJM}$		8	$\text{m}\Omega$
R_{thJC}	per diode, DC current		2.8	K/W
	per module		0.7	K/W
R_{thJK}	per diode, DC current		3.2	K/W
	per module		0.8	K/W
d_s	Creeping distance on surface		13	mm
	Creepage distance in air ③		9.5	mm
	Max. allowable acceleration		50	m/s^2

Data according to IEC 60747 and refer to a single diode unless otherwise stated

② for resistive load at bridge output, ③ with isolated fast-on tabs.



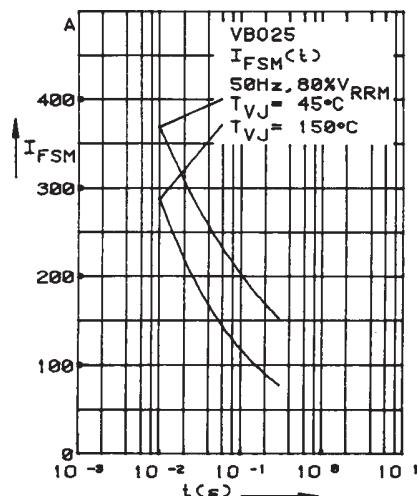


Fig. 1 Surge overload current per diode
 I_{FSM} : Crest value, t : duration

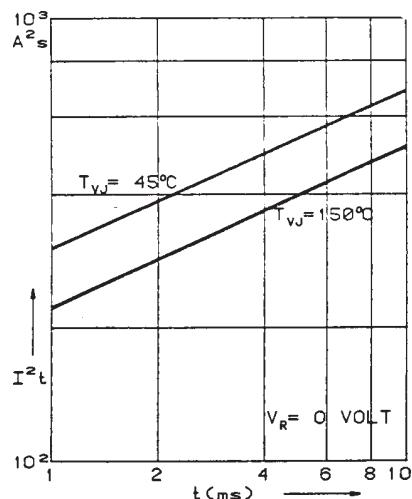


Fig. 2 I^2t versus time (1-10 ms)
 per diode

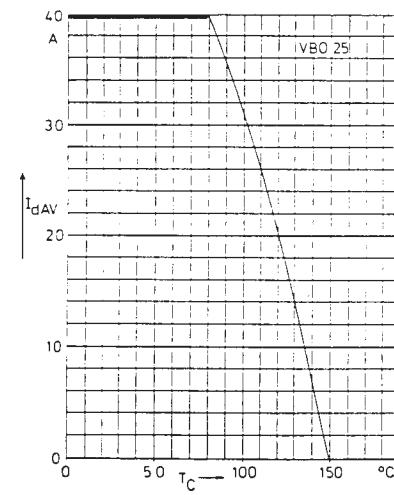


Fig. 3 Max. forward current at case temperature

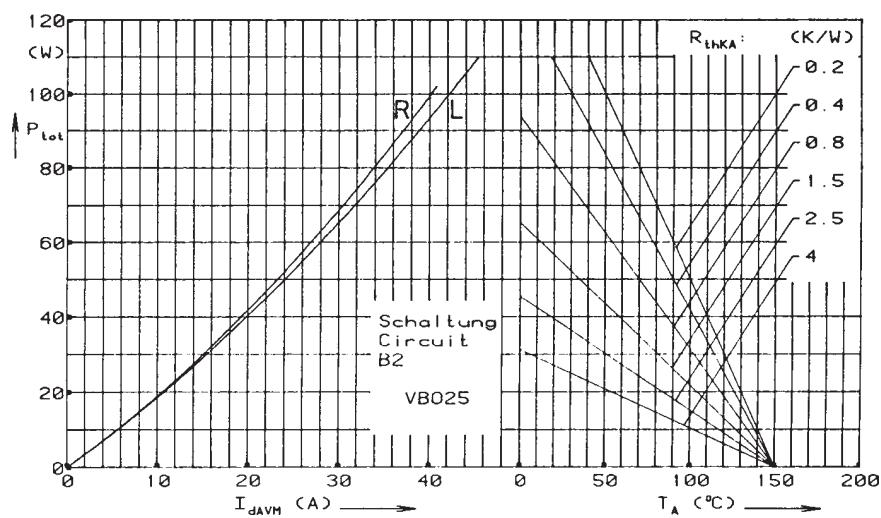


Fig. 4 Power dissipation versus direct output current and ambient temperature

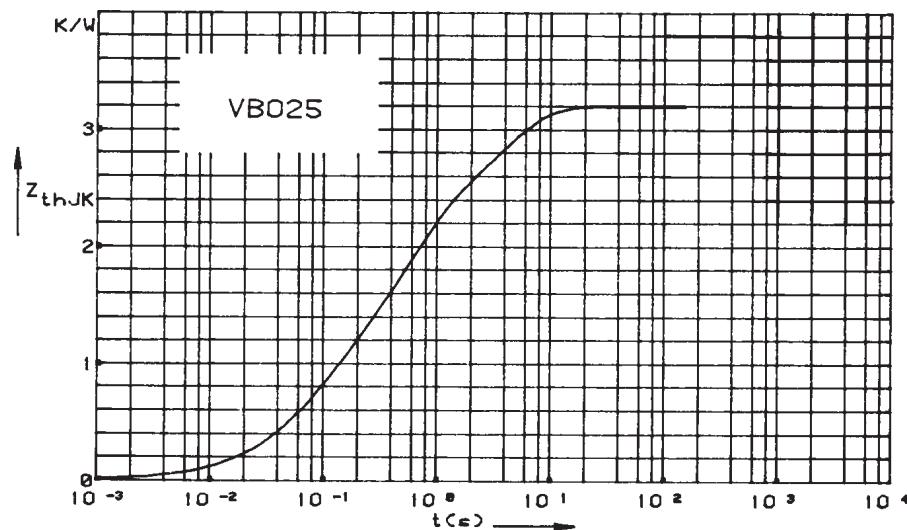


Fig. 5 Transient thermal impedance junction to heatsink per diode

IXYS reserves the right to change limits, test conditions and dimensions.

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.775	0.0788
2	1.390	0.504
3	1.055	3.701